

## Resonac Photonics Corporation Marketing Department

Marketing Department
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## **IR-46**

Color Infrared
 Materials GaAs/GaAs

3. Electrode P(anode) side : Al

N(cathode) side: Au

4. Electrode pattern Fig.1,2

5. Chip size 0.205mm X 0.205mm X 0.180mmH (Fig.1)

6. Emission area 0.185mm X 0.185mm (Fig.1)

7. Electro-Optical characteristics

Parameters	Symbol	Condition	Min	Тур	Max	Unit
Power	Ро	IF=20mA	0.7	1.2	_	mW
Forward Voltage	VF	IF=20mA	_	1.25	1.50	V
Reverse Current	IR	VR=5V	_	_	10	uA
Peak Wavelength	* λр	IF=20mA	_	945	_	nm
Spectral Radiation Bandwidth	* Δλ	IF=20mA	_	40	_	nm

- \* [\*] mark is reference data
- \* Power measurement at Resonac Photonics.
- 8. Recommended bonding method Ultra-sonic method or a combination of ultra-sonic and thermo-compression methods.

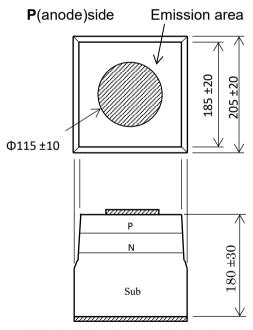


Fig.1: Chip size and Emission area

## N(cathode)side

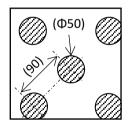


Fig.2: Electrode pattern

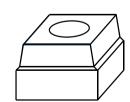


Fig.3: No roughing

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Resonac Photonics Corporation reserves the right to introduce changes without notice.